

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

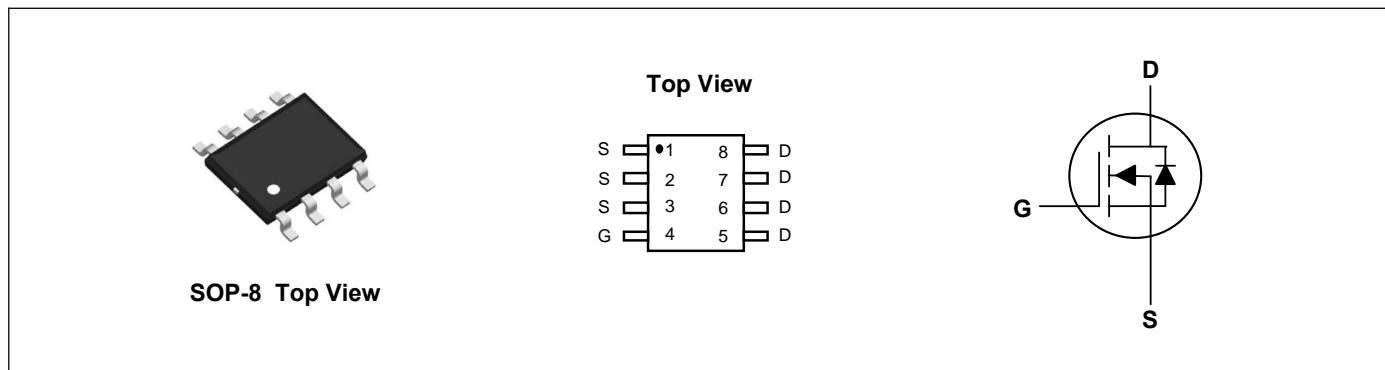
Product Summary



| | | |
|----------------------------------|-----|----|
| V_{DS} | 100 | V |
| I_D | 8.5 | A |
| $R_{DS(ON)}$ (at $V_{GS}=10V$) | 20 | mΩ |
| $R_{DS(ON)}$ (at $V_{GS}=4.5V$) | 25 | mΩ |

Applications

- High Frequency Point-of-Load,Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch



Absolute Maximum Ratings($T_A=25^\circ C$, unless otherwise noted)

| Parameter | Symbol | Rating | Units |
|--|------------------------|------------|-------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current, $V_{GS} @ 10V^1$ | $I_D @ T_A=25^\circ C$ | 8.5 | A |
| Continuous Drain Current, $V_{GS} @ 10V^1$ | $I_D @ T_A=70^\circ C$ | 6 | A |
| Pulsed Drain Current ² | I_{DM} | 40 | A |
| Single Pulse Avalanche Energy ³ | EAS | 16 | mJ |
| Avalanche Current | I_{AS} | 18 | A |
| Total Power Dissipation ⁴ | $P_D @ T_A=25^\circ C$ | 2.5 | W |
| Storage Temperature Range | T_{STG} | -55 to 150 | °C |
| Operating Junction Temperature Range | T_J | -55 to 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Unit |
|---|-----------------|-----|-----|------|
| Thermal Resistance Junction-Ambient ¹ ($t \leq 10s$) | $R_{\theta JA}$ | --- | 50 | °C/W |
| Thermal Resistance Junction-Ambient ¹ (Steady State) | | --- | 85 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|--|--|---|-----|------|-----------|----------------------------|
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$ | 100 | --- | --- | V |
| BV_{DSS} Temperature Coefficient | $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | Reference to 25°C , $I_D=1\text{mA}$ | --- | 0.08 | --- | $\text{V}/^\circ\text{C}$ |
| Static Drain-Source On-Resistance ² | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=10\text{V}$, $I_D=7\text{A}$ | --- | 16 | 20 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}$, $I_D=5\text{A}$ | --- | 19 | 25 | $\text{m}\Omega$ |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$ | 1.2 | --- | 2.5 | V |
| $V_{\text{GS}(\text{th})}$ Temperature Coefficient | $\Delta V_{\text{GS}(\text{th})}$ | | --- | -5.5 | --- | $\text{mV}/^\circ\text{C}$ |
| Drain-Source Leakage Current | I_{DSS} | $V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | 10 | uA |
| | | $V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=55^\circ\text{C}$ | --- | --- | 100 | |
| Gate-Source Leakage Current | I_{GSS} | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |
| Forward Transconductance | g_{fs} | $V_{\text{DS}}=5\text{V}$, $I_D=7\text{A}$ | --- | 24 | --- | S |
| Gate Resistance | R_g | $V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 1.6 | --- | Ω |
| Total Gate Charge (10V) | Q_g | $V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=7\text{A}$ | --- | 36 | --- | nC |
| Gate-Source Charge | Q_{gs} | | --- | 5 | --- | |
| Gate-Drain Charge | Q_{gd} | | --- | 10 | --- | |
| Turn-On Delay Time | $T_{\text{d}(\text{on})}$ | $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=3.3\Omega$, $I_D=7\text{A}$ | --- | 11.5 | --- | ns |
| Rise Time | T_r | | --- | 29 | --- | |
| Turn-Off Delay Time | $T_{\text{d}(\text{off})}$ | | --- | 42 | --- | |
| Fall Time | T_f | | --- | 18 | --- | |
| Input Capacitance | C_{iss} | $V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 1930 | --- | pF |
| Output Capacitance | C_{oss} | | --- | 245 | --- | |
| Reverse Transfer Capacitance | C_{rss} | | --- | 125 | --- | |

Drain-Source Diode Characteristics

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|--|-----------------|---|-----|-----|-----|-------------|
| Continuous Source Current ^{1,5} | I_s | $V_G=V_D=0\text{V}$, Force Current | --- | --- | 7 | A |
| Pulsed Source Current ^{2,5} | I_{SM} | | --- | --- | 40 | A |
| Diode Forward Voltage ² | V_{SD} | $V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | 1.2 | V |
| Reverse Recovery Time | t_{rr} | $I_F=7\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$ | --- | 48 | --- | nS |
| | Q_{rr} | | --- | 29 | --- | nC |

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}=25\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

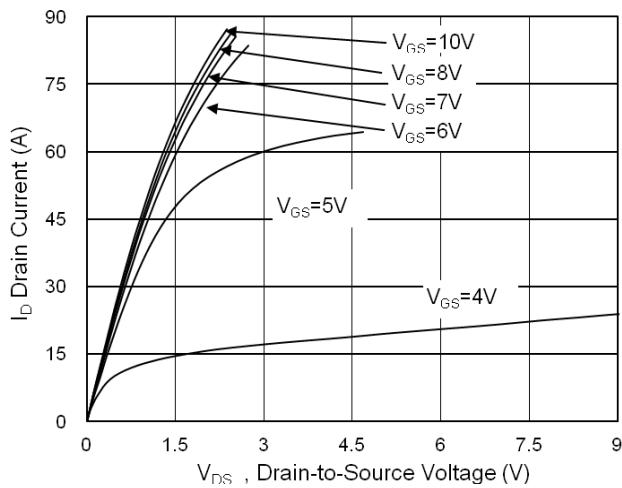


Fig.1 Typical Output Characteristics

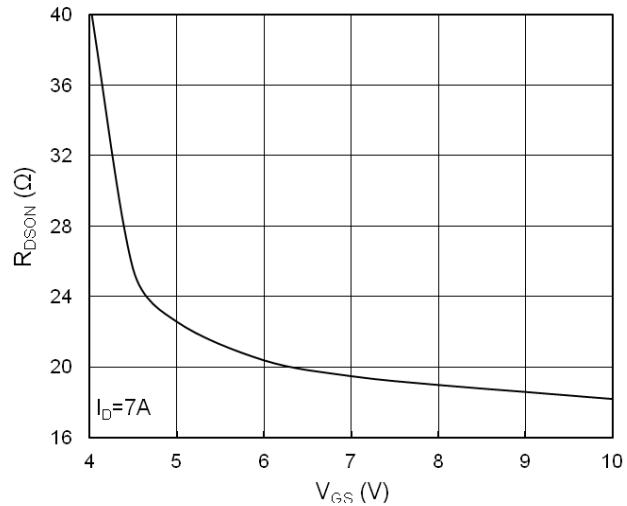


Fig.2 On-Resistance vs. G-S Voltage

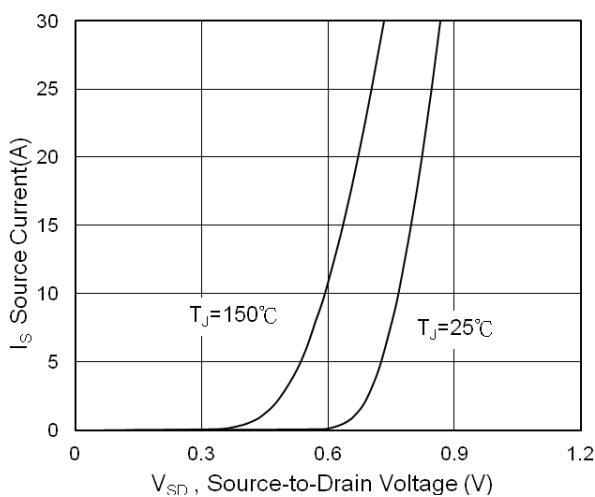


Fig.3 Source Drain Forward Characteristics

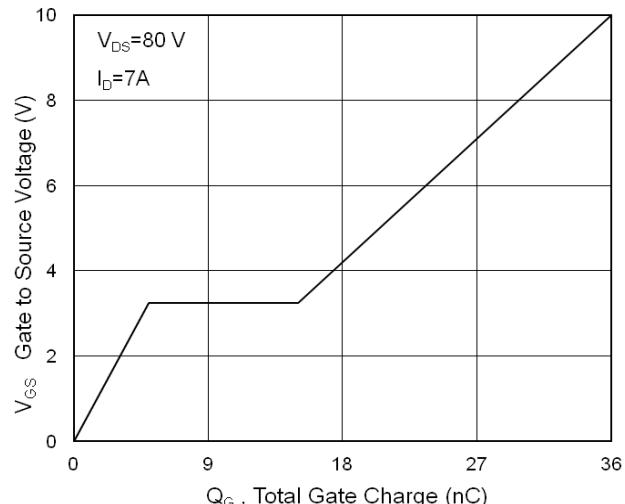


Fig.4 Gate-Charge Characteristics

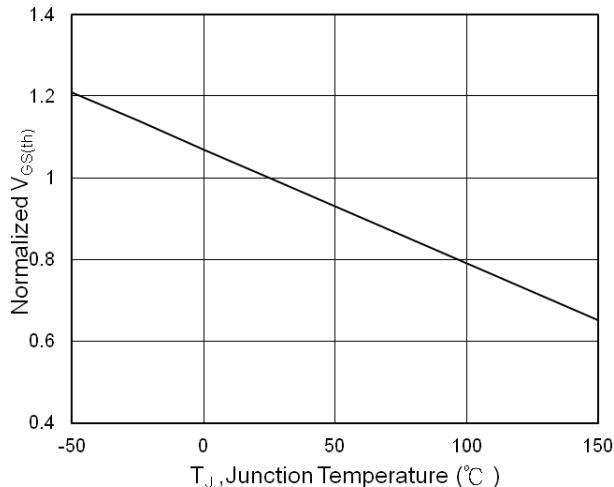


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

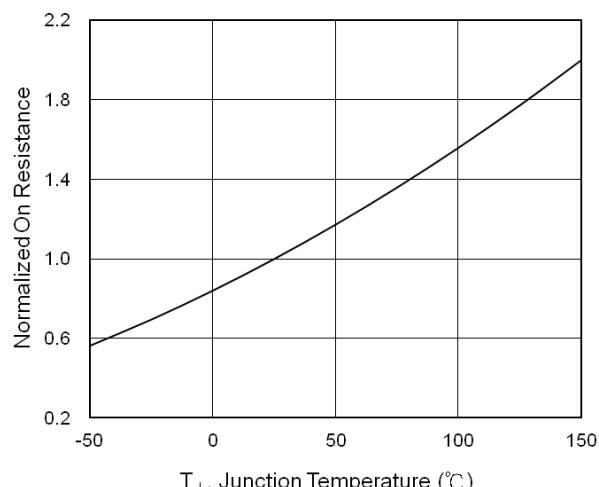
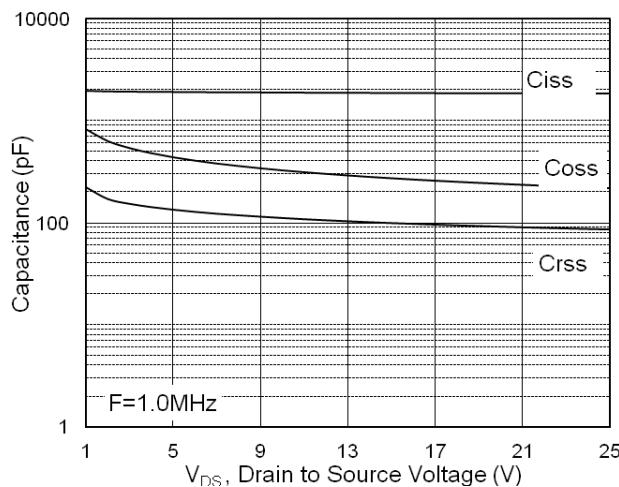
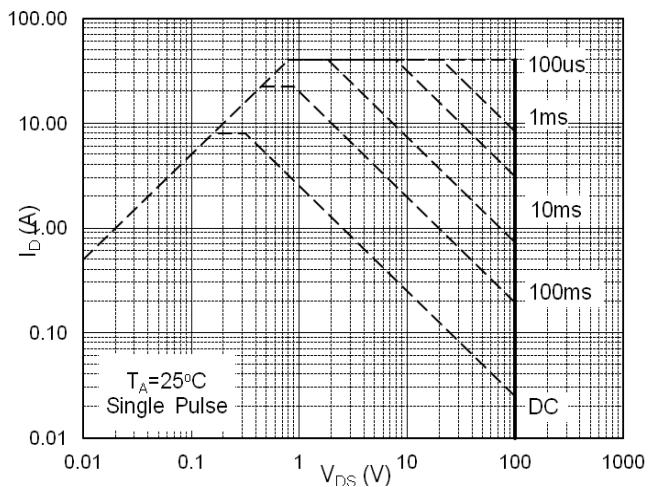
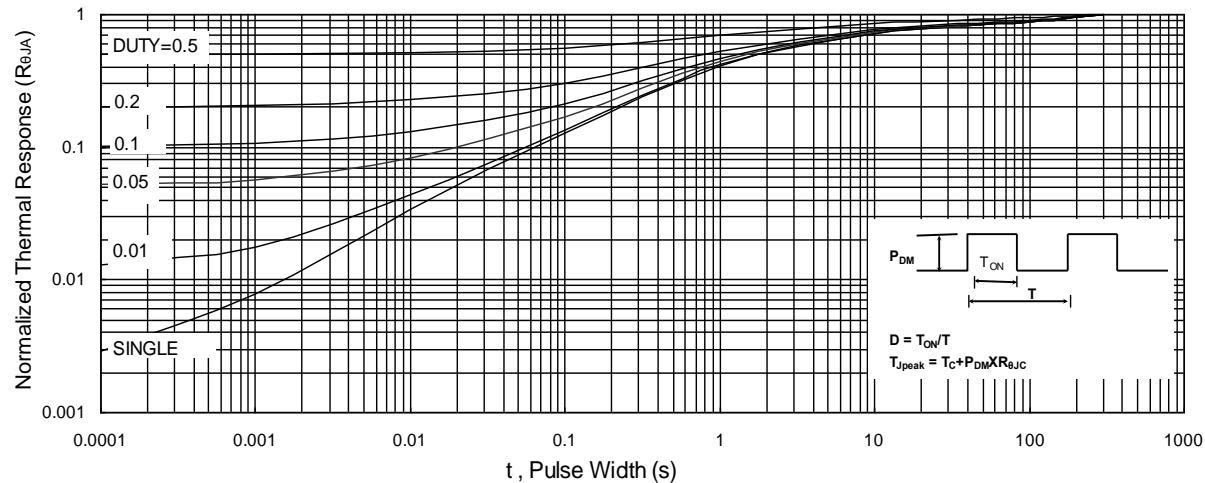
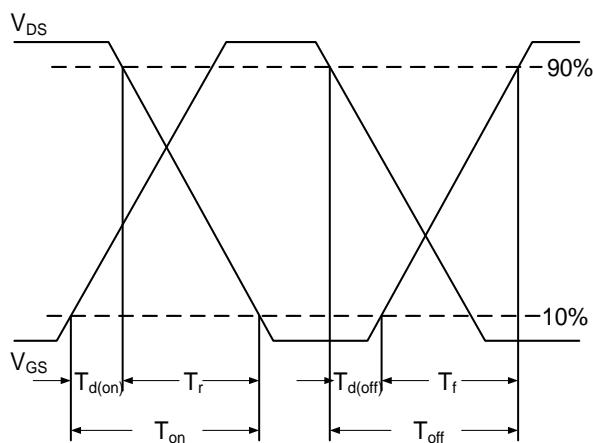
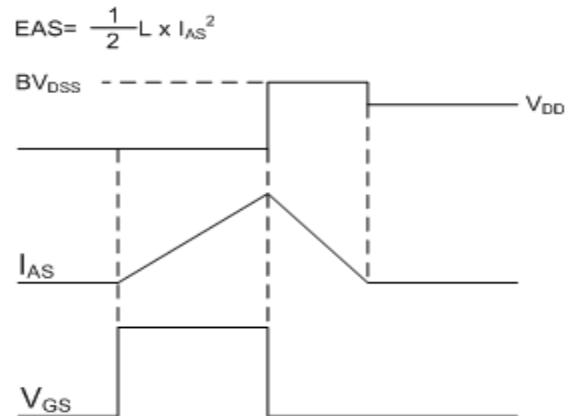
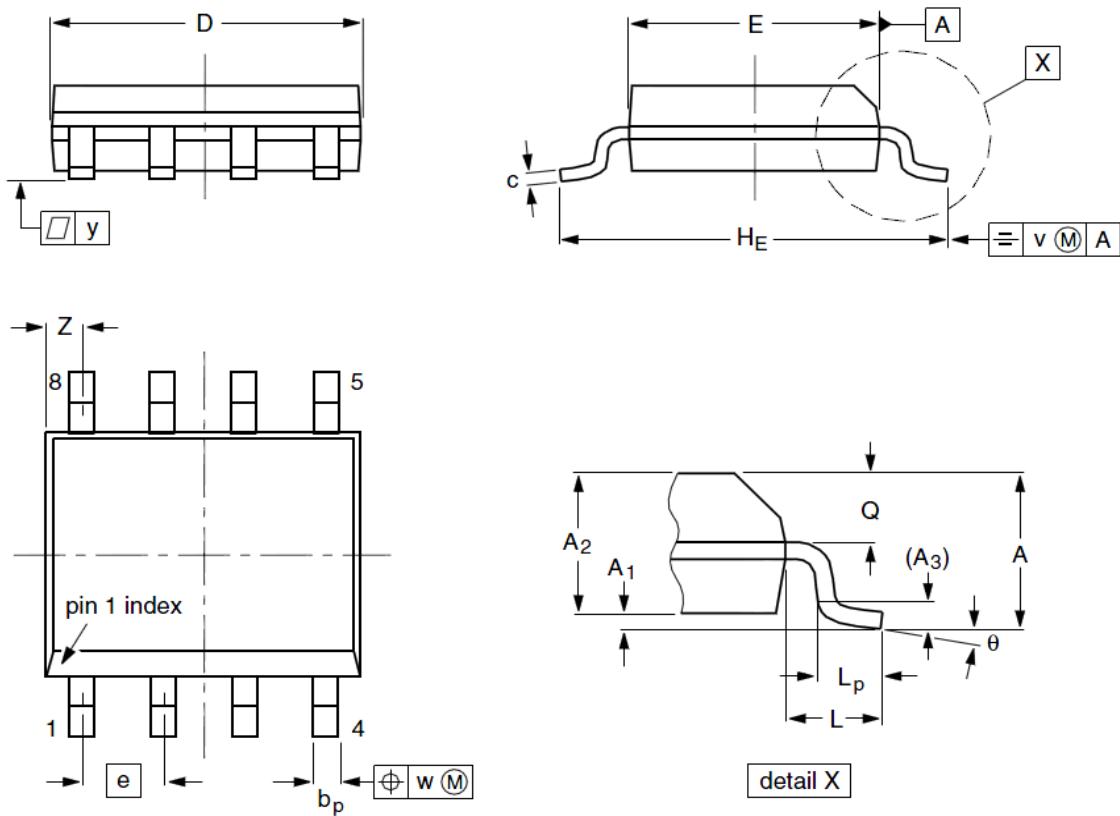


Fig.6 Normalized $R_{DS(on)}$ vs. T_J


Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

Fig.10 Switching Time Waveform

Fig.11 Unclamped Inductive Switching Waveform

SOP-8 Package Outline Dimensions



| Symbol | Dimensions (unit:mm) | | | Symbol | Dimensions (unit:mm) | | |
|----------------------|-----------------------------|------------|------------|----------------------|-----------------------------|------------|------------|
| | Min | Typ | Max | | Min | Typ | Max |
| A | 1.35 | 1.55 | 1.75 | A₁ | 0.10 | 0.18 | 0.25 |
| A₂ | 1.25 | 1.45 | 1.65 | A₃ | -- | 0.25 | -- |
| b_p | 0.36 | 0.42 | 0.51 | c | 0.19 | 0.22 | 0.25 |
| D | 4.70 | 4.92 | 5.10 | E | 3.80 | 3.90 | 4.00 |
| e | -- | 1.27 | -- | H_E | 5.80 | 6.00 | 6.20 |
| L | -- | 1.05 | -- | L_P | 0.40 | 0.68 | 1.00 |
| Q | 0.60 | 0.65 | 0.73 | v | -- | 0.25 | -- |
| w | -- | 0.25 | -- | y | -- | 0.10 | -- |
| Z | 0.30 | 0.50 | 0.70 | θ | 0° | | 8° |